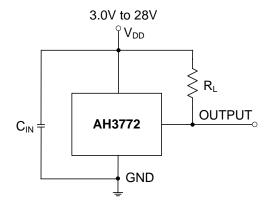


Typical Applications Circuit (Note 4)



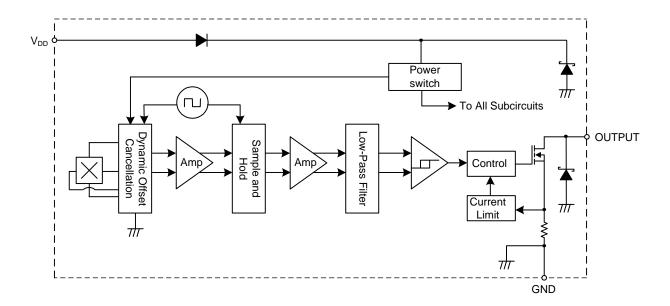
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF. R_L is the pull-up resistor.

Pin Descriptions

Package: SOT23 and SIP-3

Pin Number	Pin Name	Function			
1	V_{DD}	Power Supply Input			
2	GND	Ground			
3	OUTPUT	Output Pin			

Functional Block Diagram





Absolute Maximum Ratings (Notes 5 & 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Characteristic		Value	Unit	
V_{DD}	Supply Voltage (Note 6)		32	V	
V_{DDR}	Reverse-Supply Voltage		-32	V	
V _{OUT_MAX}	Output-Off Voltage (Note 6)		32V	V	
l _{out}	Continuous-Output Current	60	mA		
I _{OUT_R}	Reverse-Output Current	-50	mA		
В	Magnetic-Flux Density		Unlimited		
Ъ	Package Power Dissipation	SIP-3	550	mW	
P_D	Fackage Fower Dissipation	SC59 and SOT23	230	IUAA	
Ts	Storage Temperature Range		-65 to +165	°C	
TJ	Maximum Junction Temperature		+150	°C	
ESD	Electrostatic Discharge Withstand Capability—Human Body Mo	odel	6	kV	

Notes

- 5. Stresses greater than the Absolute Maximum Ratings specified above can cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
- 6. The absolute maximum V_{DD} of 32V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum-rated conditions for any period of time.

Recommended Operating Conditions (@T_A = -40°C to +125°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V_{DD}	Supply Voltage	Operating	3.0 to 28	V
T _A	Operating Temperature Range	Operating	-40 to +125	°C

Electrical Characteristics (Notes 7 & 8) (@T_A = -40°C to +125°C, V_{DD} = 3V to 28V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OUT_ON}	Output-On Voltage	$I_{OUT} = 20$ mA, B > B _{OP}	_	0.2	0.4	V
I _{OUT_OFF}	Output-Leakage Current	V _{OUT} = 28V, B < B _{RP} , Output off	_	<0.1	10	μΑ
1	Supply Current	Output open, T _A = +25°C	_	3	1	mA
I _{DD}		Output open, $T_A = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$	_		4	mA
I _{DD R}	Reverse-Battery Current	$V_{DD} = -18V$, $T_A = -40$ °C to $+125$ °C	_	-0.01	1	mA
א_טטי	Reverse-Battery Current	$V_{DD} = -28V$, $T_A = -40$ °C to $+125$ °C	_	-0.01	1.5	mA
t _{ST}	Device Start-Up Time	$V_{DD} >= 3V, B > B_{OP} (Note 7)$	_	10	1	μs
f _c	Chopping Frequency	$V_{DD} >= 3V$	_	800	1	kHz
t _d	The time delay from magnetic threshold reached to the start of the output rise or fall	(Note 9)	_	3.75	-	μs
t _r	Output Rising Time (external pull-up resistor R∟and load capacitance dependent)	$R_L = 1k\Omega$, $C_L = 20pF$	_	0.2	1	μs
t _f	Output Falling Time (Internal switch resistance and load capacitance dependent)	$R_L = 1k\Omega$, $C_L = 20pF$	_	0.1	1	μs
I _{OCL}	Output Current Limit	B>B _{OP} , (Note 10)	30		55	mA
Vz	Zener Clamp Voltage	I _{DD} = 5mA	28	_	_	V

Notes:

- 7. When power is initially turned on, Voo must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.
- 8. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization
- 9. Guaranteed by design, process control, and characterization. Not tested in production.
- 10. The device limits the output current I_{OUT} to current limit of I_{OCL}.



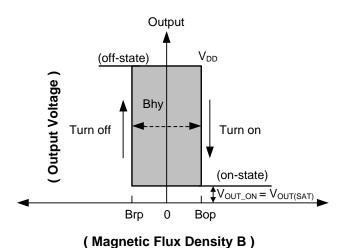
Magnetic Characteristics (Notes 11 &12) (T_A = -40°C to +125°C, V_{DD} = 3.0V to 28V, unless otherwise specified)

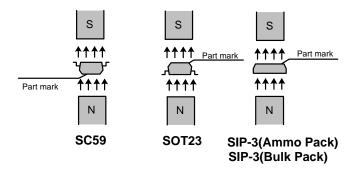
(1mT=10 Gauss)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Real (South pole to part marking side)	Operation Point	V _{DD} = 12V, T _A = +25°C	1	25	1	
B _{OP} (South pole to part-marking side)	Operation Folia	$T_A = -40$ °C to +125°C			40	
B _{RP} (North pole to part-marking side)	Release Point	V _{DD} = 12V, T _A = +25°C		-25		Gauss
	Release Form	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$	-40	-25	-10	Gauss
D (ID ID)	Hystorogis (Note 12)	V _{DD} = 12V, T _A = +25°C	_	50	_	
B _{HY} (B _{OPX} - B _{RPX})	Hysteresis (Note 13)	T _A = -40°C to +125°C	20	50	80	

Notes:

- 11. When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.
- 12. Typical values are defined at $T_A = +25^{\circ}C$, $V_{DD} = 12V$. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control, and characterization.
- 13. Maximum and minimum hysteresis is guaranteed by design, process control, and characterization.

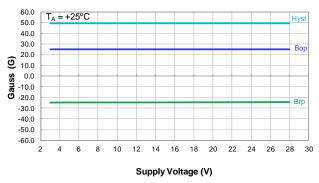




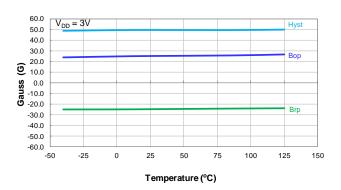


Typical Operating Characteristics

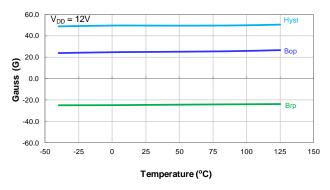
Magnetic Operating Switch Points—BOP and BRP



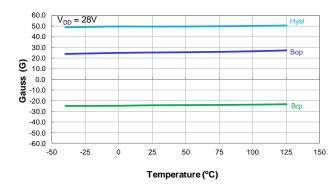
Switch Points B_{OP} and B_{RP} vs Supply Voltage



Switch Points BOP and BRP vs Temperature

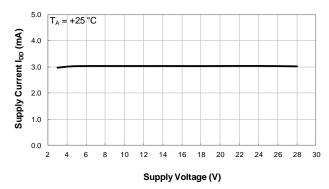


Switch Points BOP and BRP vs Temperature

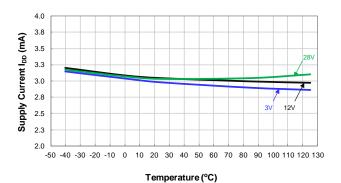


Switch Points B_{OP} and B_{RP} vs Temperature

Supply Current



Supply Current vs Supply Voltage

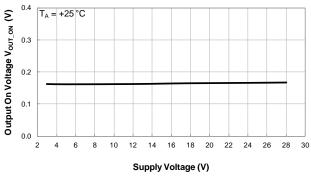


Supply Current vs Temperature

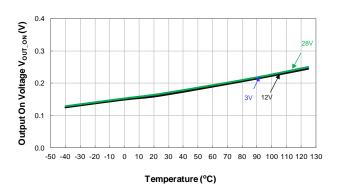


Typical Operating Characteristics (continued)

Output Switch On Voltage

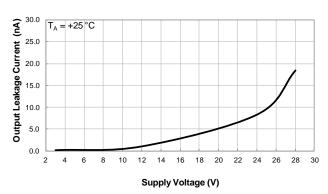


Output On Voltage vs Supply Voltage

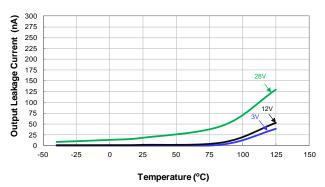


Output On Voltage vs Temperature

Output Switch Leakage Current

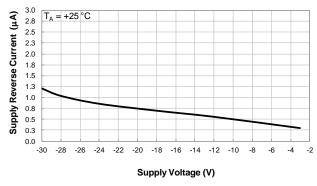


Output Leakage Current vs Supply Voltage

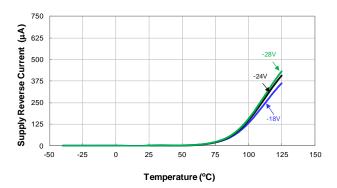


Output Leakage Current vs Temperature

Supply Reverse Current



Supply Reverse Current vs Supply Voltage



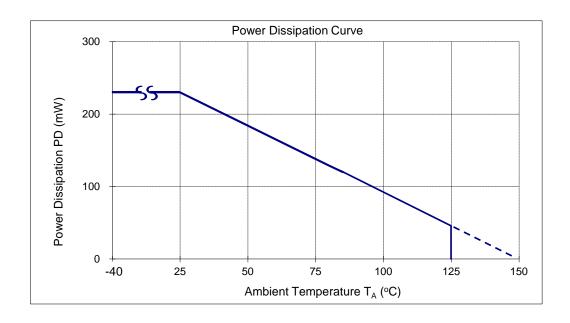
Supply Reverse Current vs Temperature



Thermal Performance Characteristics

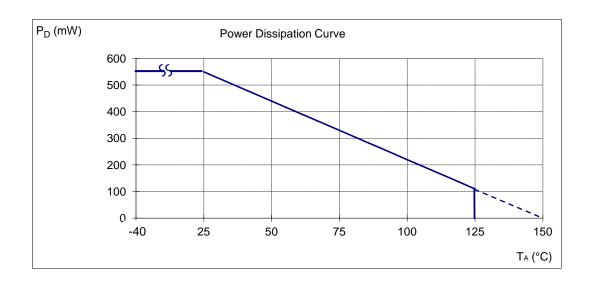
(1) Package types: SOT23 and SC59

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0



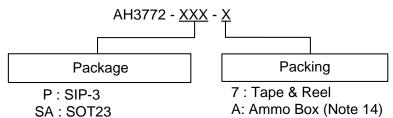
(2) Package type: SIP-3

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	550	440	396	362	308	286	264	220	198	176	132	110	88	44	0





Ordering Information



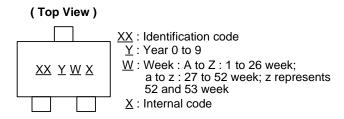
B: Bulk (Note 15) W: SC59

	Package	Packaging	Е	Bulk		d Reel	Amm	ю Вох
Part Number	Code	rackaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3772-P-A	Р	SIP-3	_	_	_	_	4000/Box	-A
AH3772-P-B	Р	SIP-3	1000	-B	_	_	_	_
AH3772-SA-7	SA	SOT23	_	_	3000/Tape & Reel	-7	_	_
AH3772-W-7	W	SC59	_	_	3000/Tape & Reel	-7	_	_

14. Ammo Box is for SIP-3 Spread Lead.15. Bulk is for SIP-3 Straight Lead. Notes:

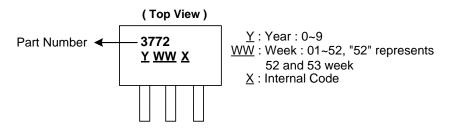
Marking Information

(1) Package Type: SOT23 and SC59



Part Number	Package	Identification Code
AH3772	SOT23	WV
AH3772	SC59	YV

(2) Package Type: SIP-3



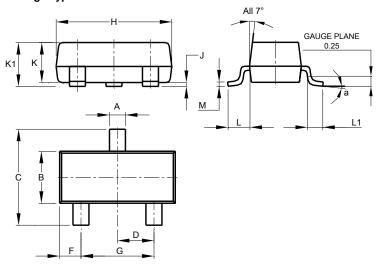
Part Number	Package	Identification Code
AH3772	SIP-3	3772



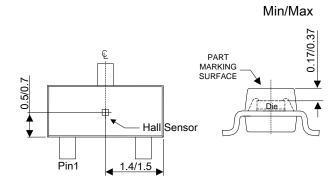
Package Outline Dimensions (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT23



	SO	T23	
Dim	Min	Max	Тур
Α	0.37	0.51	0.40
В	1.20	1.40	1.30
С	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
Н	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
а	0°	8°	-
All	Dimens	ions in	mm



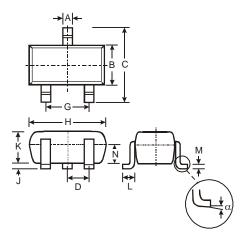
Sensor Location



Package Outline Dimensions (cont.) (All dimensions in mm.)

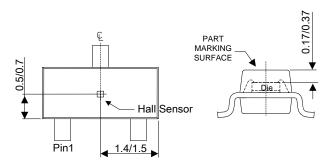
Please see http://www.diodes.com/package-outlines.html for the latest version.

(2) Package Type: SC59



	SC	59	
Dim	Min	Max	Тур
Α	0.35	0.50	0.38
В	1.50	1.70	1.60
С	2.70	3.00	2.80
D	-	-	0.95
G	-	-	1.90
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
N	0.70	0.80	0.75
α	0°	8°	-
All E	Dimens	ions in	mm

Min/Max



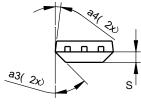
Sensor Location

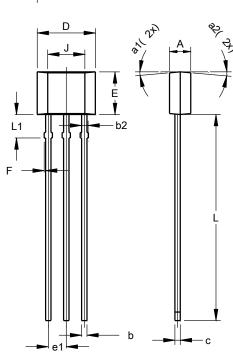


Package Outline Dimensions (continued) (All dimensions in mm.)

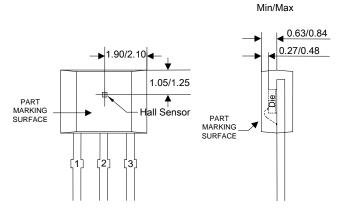
Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) Package Type: SIP-3 Bulk





SIP-3 (Bulk Pack)				
Dim	Min	Max	Тур	
Α	1.40	1.60	1.50	
b	0.33	0.43	0.38	
b2	0.40	0.508	0.46	
С	0.35	0.41	0.38	
D	3.90	4.30	4.10	
Е	2.80	3.20	3.00	
e1	1.24	1.30	1.27	
F	0.00	0.20		
J	2.62 REF			
L	14.00	15.00	14.50	
L1	1.55	1.75	1.65	
S	0.63	0.84	0.74	
a1			5°	
a2			5°	
а3			45°	
a4			3°	
All Dimensions in mm				



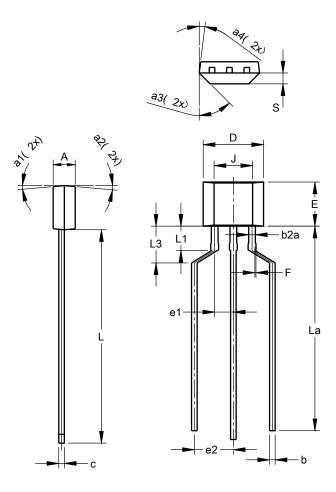
Sensor Location



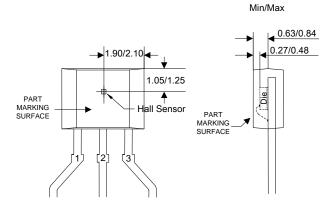
Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(4) Package Type: SIP-3 Ammo Pack



SIP-3				
(Ammo Pack)				
Dim	Min	Max	Тур	
Α	1.40	1.60	1.50	
b	0.33	0.43	0.38	
b2a	0.40	0.52	0.46	
С	0.35	0.41	0.38	
D	3.90	4.30	4.10	
Е	2.80	3.20	3.00	
e1	1.24	1.30	1.27	
e2	2.40	2.90	2.65	
F	0.00	0.20	_	
J	2.62 REF			
L	14.00	15.00	14.50	
La	12.90	14.90	13.90	
L1	1.55	1.75	1.65	
L3	2.00	3.00	2.50	
S	0.63	0.84	0.74	
a1	_	_	5°	
a2	_	_	5°	
а3	_	_	45°	
a4	_	_	3°	
All Dimensions in mm				



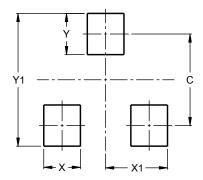
Sensor Location



Suggested Pad Layout

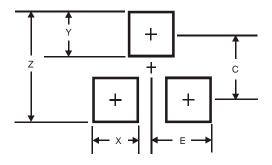
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9

(2) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
X	0.8
Y	1.0
С	2.4
F	1 35



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